



Features

- ◆ Pb free product
- ◆ Low power consumption
- ◆ General purpose
- ◆ Reliable and rugged
- ◆ Long life

LIGH



Electrical Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Radiant Intensity	I _e	10.5	14.0	18.5	mW/sr	I _F =50mA (Note 1,3)

Viewing Angle

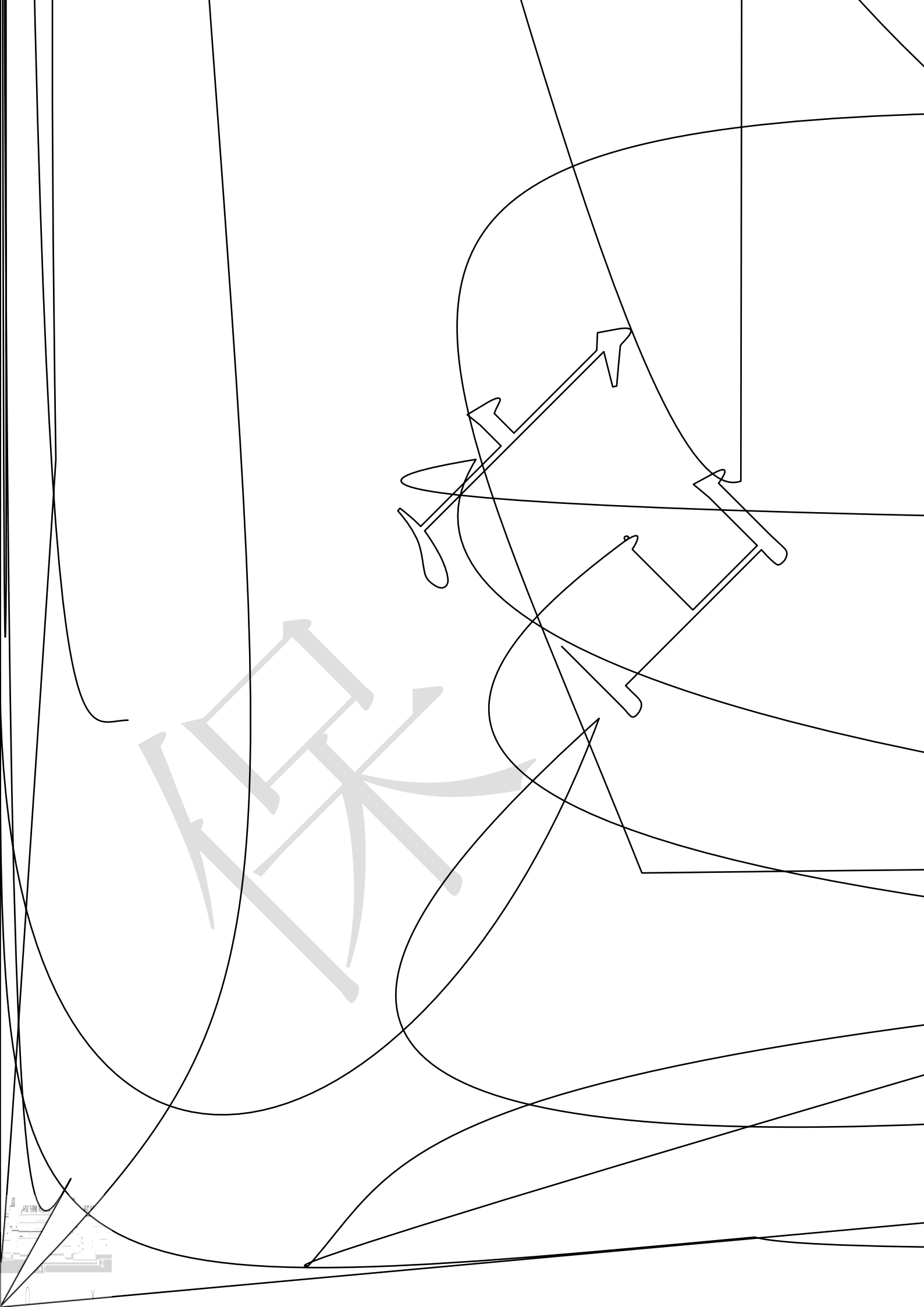
Infrared Emitting Diode Specification

●Commodity: Infrared emitting diode

●Intensity Bin Limits (At 50mA)

BIN CODE	Min.(mW/sr)	Max.(mW/sr)
27	10.5	14.0
28	14.0	18.5

Typical Electrical / Optical Characteristics Curves
(25



LEAD FORMING PROCEDURES

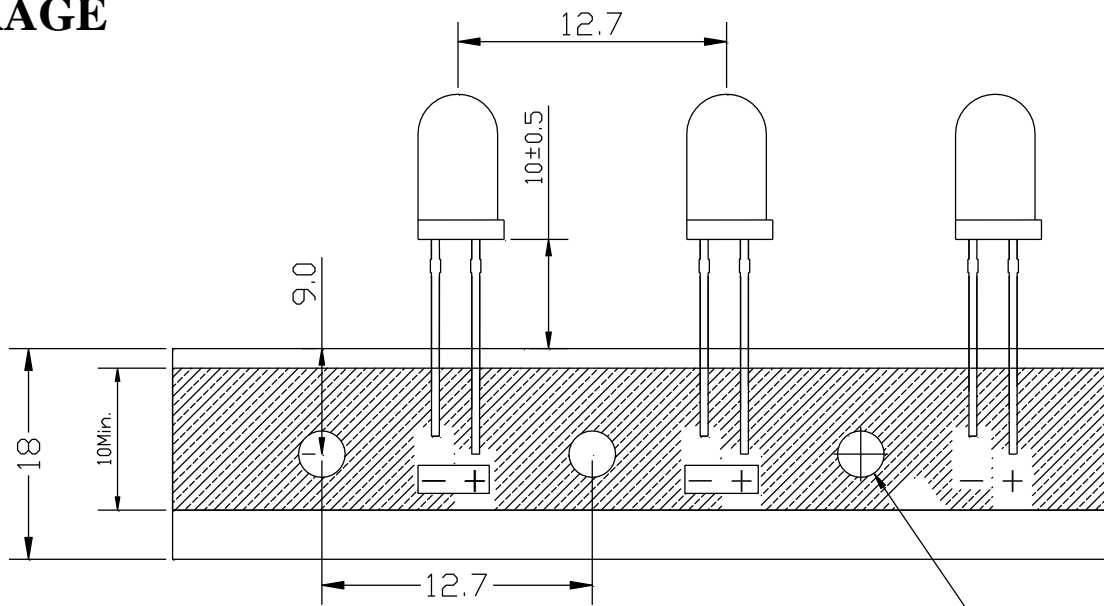
1. Maintain a minimum of lead bend (Fig.5 and Fig.6).

2. Lead forming or bending soldering.

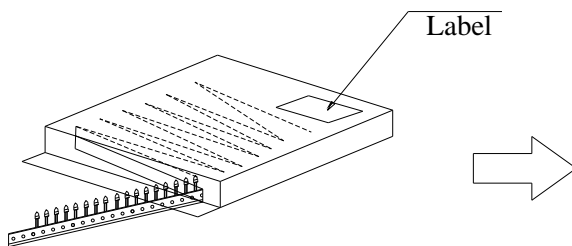
3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.

4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead

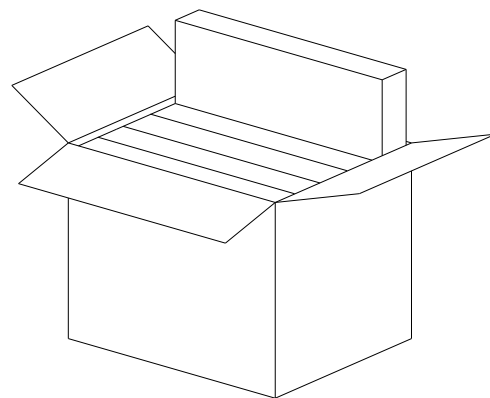
PACKAGE



All dimensions are in millimeters. Tolerance is $\pm 0.20\text{mm}$ unless otherwise noted.



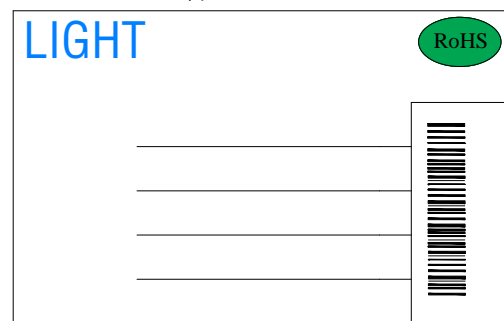
Inner Cardboard Box



Outer Cardboard Box

标签 Label

Packaging Unit	Quantity
Inner Cardboard Box	2000 / 2000 pcs/box
Outer Cardboard Box	20 / 20 boxes/box



Others

The appearance and specifications of the product may be modified for improvement, without prior notice.